



Click [here](#) for the 3D model.

General Information

| | |
|--------------------------|---|
| Series | SMD Comm X7R |
| Style | SMD Chip |
| Description | SMD, MLCC, Temperature Stable, Class II |
| Features | Temperature Stable, Class II |
| RoHS | Yes |
| Termination | Tin |
| Marking | true |
| AEC-Q200 | No |
| Typical Component Weight | 4.8 mg |
| Shelf Life | 78 Weeks |
| MSL | 1 |

Specifications

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|--|---|
| Capacitance | 0.01 uF |
| Measurement Condition | 1 kHz 1.0Vrms |
| Capacitance Tolerance | 5% |
| Voltage DC | 25 VDC |
| Dielectric Withstanding Voltage | 62.5 VDC |
| Temperature Range | -55/+125°C |
| Temperature Coefficient | X7R |
| Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC) | 15%, 1kHz 1.0Vrms |
| Dissipation Factor | 3.5% 1 kHz 1.0Vrms |
| Aging Rate | 3% Loss/Decade Hour: Referee Time is 48 Hours |
| Insulation Resistance | 10 GOhms |

Dimensions

| | |
|-----------|------------------|
| Chip Size | 0603 |
| L | 1.6mm +/-0.15mm |
| W | 0.8mm +/-0.15mm |
| T | 0.8mm +/-0.10mm |
| S | 0.5mm MIN |
| B | 0.35mm +/-0.15mm |

Packaging Specifications

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|--------------------|------------------------|
| Packaging | T&R, 180mm, Paper Tape |
| Packaging Quantity | 4000 |

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